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LTC4252-1/LTC4252-2 LTC4252A-1/LTC4252A-2

Negative Voltage Hot Swap Controllers

FEATURES

- Allows Safe Board Insertion and Removal from a Live – 48V Backplane
- Floating Topology Permits Very High Voltage Operation
- Current Limit With Circuit Breaker Timer
- Fast Response Time Limits Peak Fault Current
- Programmable Soft-Start Current Limit
- Programmable Timer with Drain Voltage Accelerated Response
- ±1% Undervoltage/Overvoltage Threshold Accuracy (LTC4252A)
- Adjustable Undervoltage/Overvoltage Protection
- LTC4252-1/LTC4252A-1: Latch Off After Fault
- LTC4252-2/LTC4252A-2: Automatic Retry After Fault
- Available in 8-Pin and 10-Pin MSOP Packages

APPLICATIONS

- Hot Board Insertion
- Electronic Circuit Breaker
- -48V Distributed Power Systems
- Negative Power Supply Control
- Central Office Switching
- High Availability Servers
- ATCA

DESCRIPTION

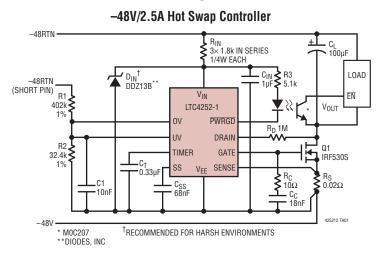
The LTC®4252 negative voltage Hot Swap™ controller allows a board to be safely inserted and removed from a live backplane. Output current is controlled by three stages of current limiting: a timed circuit breaker, active current limiting and a fast feedforward path that limits peak current under worst-case catastrophic fault conditions.

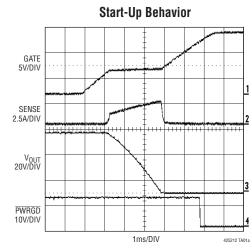
Adjustable undervoltage and overvoltage detectors disconnect the load whenever the input supply exceeds the desired operating range. The LTC4252's supply input is shunt regulated, allowing safe operation with very high supply voltages. A multifunction timer delays initial start-up and controls the circuit breaker's response time. The circuit breaker's response time is accelerated by sensing excessive MOSFET drain voltage, keeping the MOSFET within its safe operating area (SOA). An adjustable soft-start circuit controls MOSFET inrush current at start-up.

The LTC4252-1/LTC4252A-1 latch off after a circuit breaker fault times out. The LTC4252-2/LTC4252A-2 provide automatic retry after a fault. The LTC4252A-1/LTC4252A-2 feature tight ±1% undervoltage/overvoltage threshold accuracy. The LTC4252 is available in either an 8-pin or 10-pin MSOP, while the LTC4252A is available in the 10-pin MSOP.

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TYPICAL APPLICATION







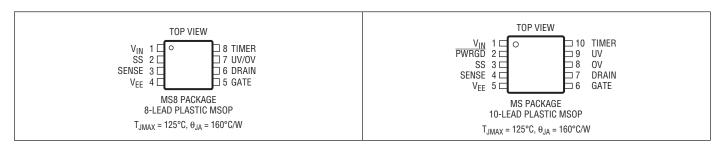
ABSOLUTE MAXIMUM RATINGS

All Voltages Referred to V_{EE} (Note 1)

Current into V _{IN} (100µs Pulse)	100mA
V _{IN} , DRAIN Pin Minimum Voltage	0.3V
Input/Output Pins	
(Except SENSE and DRAIN) Voltage	0.3V to 16V
SENSE Pin Voltage	0.6V to 16V
Current Out of SENSE Pin (20µs Pulse)	200mA
Current into DRAIN Pin (100µs Pulse)	20mA
Maximum Junction Temperature	125°C

Operating Temperature Range	
LTC4252-1C/LTC4252-2C	
LTC4252A-1C/LTC4252A-2C 0°C to 7	0°C
LTC4252-1I/LTC4252-2I	
LTC4252A-1I/LTC4252A-2I40°C to 8	5°C
Storage Temperature Range65°C to 15	0°C
Lead Temperature (Soldering, 10 sec)30	0°C

PIN CONFIGURATION



ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC4252-1CMS8#PBF	LTC4252-1CMS8#TRPBF	LTWM	8-Lead Plastic MSOP	0°C to 70°C
LTC4252-2CMS8#PBF	LTC4252-2CMS8#TRPBF	LTWP	8-Lead Plastic MSOP	0°C to 70°C
LTC4252-1IMS8#PBF	LTC4252-1IMS8#TRPBF	LTRQ	8-Lead Plastic MSOP	-40°C to 85°C
LTC4252-2IMS8#PBF	LTC4252-2IMS8#TRPBF	LTRR	8-Lead Plastic MSOP	-40°C to 85°C
LTC4252-1CMS#PBF	LTC4252-1CMS#TRPBF	LTWN	10-Lead Plastic MSOP	0°C to 70°C
LTC4252-2CMS#PBF	LTC4252-2CMS#TRPBF	LTWQ	10-Lead Plastic MSOP	0°C to 70°C
LTC4252A-1CMS#PBF	LTC4252A-1CMS#TRPBF	LTAFX	10-Lead Plastic MSOP	0°C to 70°C
LTC4252A-2CMS#PBF	LTC4252A-2CMS#TRPBF	LTAGE	10-Lead Plastic MSOP	0°C to 70°C
LTC4252-1IMS#PBF	LTC4252-1IMS#TRPBF	LTRS	10-Lead Plastic MSOP	-40°C to 85°C
LTC4252-2IMS#PBF	LTC4252-2IMS#TRPBF	LTRT	10-Lead Plastic MSOP	-40°C to 85°C
LTC4252A-1IMS#PBF	LTC4252A-1IMS#TRPBF	LTAFY	10-Lead Plastic MSOP	-40°C to 85°C
LTC4252A-2IMS#PBF	LTC4252A-2IMS#TRPBF	LTAGF	10-Lead Plastic MSOP	-40°C to 85°C

Consult LTC Marketing for parts specified with wider operating temperature ranges.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/ For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

LINEAR TECHNOLOGY

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25 \,^{\circ}\text{C}$. (Note 2)

SYMBOL	PARAMETER	CONDITIONS		LT MIN	TC4252-1/-2 TYP MAX		LTC4252A-1 Min Typ		1/-2 MAX	UNITS
$\overline{V_Z}$	V _{IN} – V _{EE} Zener Voltage	I _{IN} = 2mA	•	11.5	13	14.5	11.5	13	14.5	V
r_Z	V _{IN} – V _{EE} Zener Dynamic Impedance	I _{IN} = 2mA to 30mA			5			5		Ω
I _{IN}	V _{IN} Supply Current	$UV = OV = 4V, V_{IN} = (V_Z - 0.3V)$	•		0.8	2		0.9	2	mA
V_{LKO}	V _{IN} Undervoltage Lockout	Coming Out of UVLO (Rising V _{IN})	•		9.2	11.5		9	10	V
V_{LKH}	V _{IN} Undervoltage Lockout Hysteresis				1			0.5		V
V _{CB}	Circuit Breaker Current Limit Voltage	$V_{CB} = (V_{SENSE} - V_{EE})$	•	40	50	60	45	50	55	mV
V _{ACL}	Analog Current Limit Voltage	V _{ACL} = (V _{SENSE} - V _{EE}), SS = Open or 2.2V	•	80	100	120				mV
V _{ACL} / V _{CB}	Analog Current Limit Voltage/ Circuit Breaker Voltage	V _{ACL} = (V _{SENSE} - V _{EE}), SS = Open or 1.4V	•				1.05	1.20	1.38	V/V
V _{FCL}	Fast Current Limit Voltage	$V_{FCL} = (V_{SENSE} - V_{EE})$	•	150	200	300	150	200	300	mV
V_{SS}	SS Voltage	After End of SS Timing Cycle			2.2			1.4		V
R _{SS}	SS Output Impedance				100	,		50		kΩ
I _{SS}	SS Pin Current	UV = 0V = 4V, V _{SENSE} = V _{EE} , V _{SS} = 0V (Sourcing)			22			28		μА
		$ UV = OV = OV, V_{SENSE} = V_{EE}, $ $V_{SS} = 2V \text{ (Sinking)} $			28			28		mA
V _{OS}	Analog Current Limit Offset Voltage				10			10		mV
V _{ACL} +V _{OS} / V _{SS}	Ratio (V _{ACL} + V _{OS}) to SS Voltage				0.05			0.05		V/V
I _{GATE}	GATE Pin Output Current	UV = 0V = 4V, V _{SENSE} = V _{EE} , V _{GATE} = 0V (Sourcing)	•	40	58	80	40	58	80	μА
		$ UV = 0V = 4V, V_{SENSE} - V_{EE} = 0.15V, \\ V_{GATE} = 3V \text{ (Sinking)} $			17			17		mA
		$ UV = 0V = 4V, V_{SENSE} - V_{EE} = 0.3V, $ $V_{GATE} = 1V (Sinking) $			190			190		mA
V_{GATE}	External MOSFET Gate Drive	$V_{GATE} - V_{EE}$, $I_{IN} = 2mA$	•	10	12	VZ	10	12	V_{Z}	V
V_{GATEH}	Gate High Threshold	$V_{GATEH} = V_{IN} - V_{GATE}$, $I_{IN} = 2mA$, for PWRGD Status (MS Only)			2.8			2.8		V
V _{GATEL}	Gate Low Threshold	(Before Gate Ramp-Up)			0.5			0.5		V
V_{UVHI}	UV Pin Threshold HIGH		•	3.075	3.225	3.375				V
V_{UVLO}	UV Pin Threshold LOW		•	2.775	2.925	3.075				V
V_{UV}	UV Pin Threshold	Low-to-High Transition	•				3.05	3.08	3.11	V
V _{UVHST}	UV Pin Hysteresis	(• for LTC4252A Only)	•		300		292	324	356	mV
V _{OVHI}	OV Pin Threshold HIGH		•	5.85	6.15	6.45				V
V _{OVLO}	OV Pin Threshold LOW		•	5.25	5.55	5.85				V
V _{OV}	OV Pin Threshold	Low-to-High Transition	•				5.04	5.09	5.14	V
V _{OVHST}	OV Pin Hysteresis	(• for LTC4252A Only)	•		600		82	102	122	mV
I _{SENSE}	SENSE Pin Input Current	UV = 0V = 4V, V _{SENSE} = 50mV	•		-15	-30		-15	-30	μA
I _{INP}	UV, OV Pin Input Current	UV = 0V = 4V	•		±0.1	±1		±0.1	±1	μA
V_{TMRH}	TIMER Pin Voltage High Threshold				4			4		V
V_{TMRL}	TIMER Pin Voltage Low Threshold				1			1		V

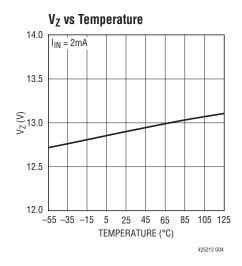


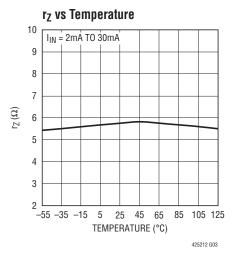
ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25 \,^{\circ}\text{C}$. (Note 2)

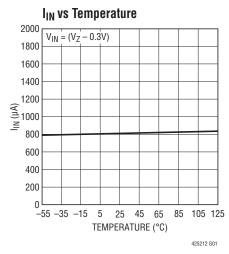
CVMDOL	PARAMETER	CONDITIONS	1	C4252-1		LTC4252A-1/-2			шите	
SYMBOL		CONDITIONS		MIN	TYP	MAX	MIN	TYP	MAX	UNITS
I _{TMR}	TIMER Pin Current	Timer On (Initial Cycle/Latchoff/ Shutdown Cooling, Sourcing), V _{TMR} = 2V			5.8			5.8		μА
		Timer Off (Initial Cycle, Sinking), V _{TMR} = 2V			28			28		mA
		Timer On (Circuit Breaker, Sourcing, I _{DRN} = 0µA), V _{TMR} = 2V			230			230		μА
		Timer On (Circuit Breaker, Sourcing, I _{DRN} = 50μA), V _{TMR} = 2V			630			630		μА
		Timer Off (Circuit Breaker/ Shutdown Cooling, Sinking), V _{TMR} = 2V			5.8			5.8		μА
$\Delta I_{TMRACC} / \Delta I_{DRN}$	$[(I_{TMR} \text{ at } I_{DRN} = 50\mu\text{A}) - (I_{TMR} \text{ at } I_{DRN} = 0\mu\text{A})]/ΔI_{DRN}$	Timer On (Circuit Breaker with I _{DRN} = 50μA)			8			8		μΑ/μΑ
V_{DRNL}	DRAIN Pin Voltage Low Threshold	For PWRGD Status (MS Only)			2.385			2.385		V
I _{DRNL}	DRAIN Leakage Current	V _{DRAIN} = 5V (4V for LTC4252A)			±0.1	±1		±0.1	±1	μА
V _{DRNCL}	DRAIN Pin Clamp Voltage	$I_{DRN} = 50\mu A$			7			6		V
V _{PGL}	PWRGD Output Low Voltage	I _{PG} = 1.6mA (MS Only) I _{PG} = 5mA (MS Only)	•		0.2	0.4 1.1		0.2	0.4 1.1	V
I _{PGH}	PWRGD Pull-Up Current	V _{PWRGD} = 0V (Sourcing) (MS Only)	•	40	58	80	40	58	80	μA
t _{SS}	SS Default Ramp Period	SS Pin Floating, V _{SS} Ramps from 0.2V to 2V			180					μѕ
		SS Pin Floating, V _{SS} Ramps from 0.1V to 0.9V						230		μѕ
t _{PLLUG}	UV Low to Gate Low				0.4			0.4		μs
t _{PHLOG}	OV High to Gate Low				0.4			0.4		μs

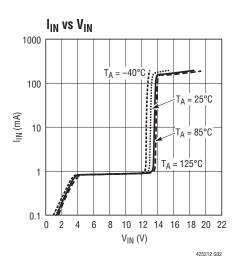
Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

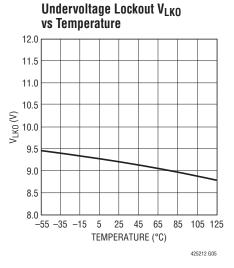
Note 2: All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to V_{EE} unless otherwise specified.

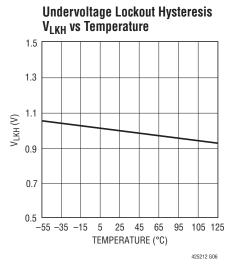


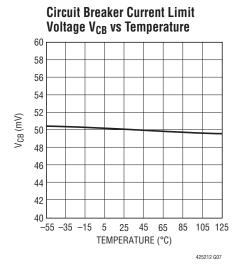


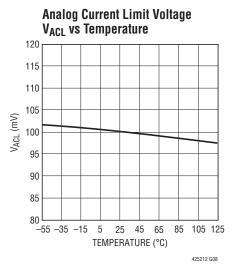


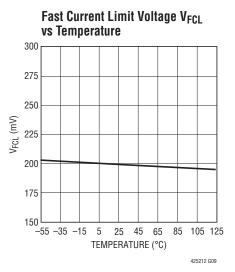


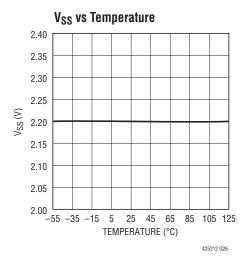


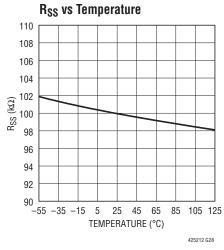


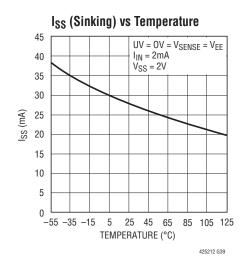


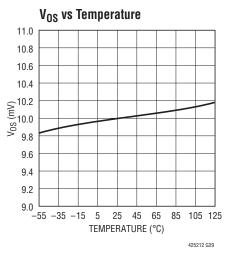


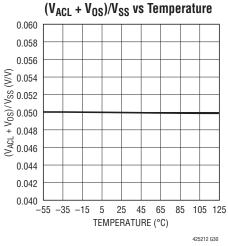


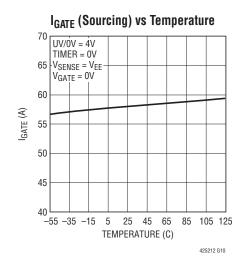


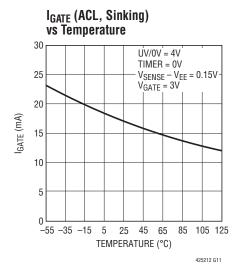


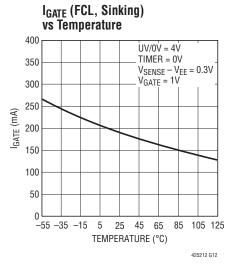


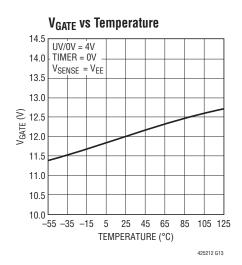




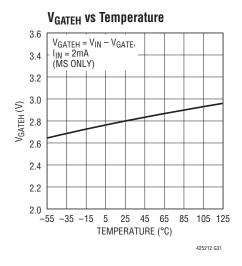


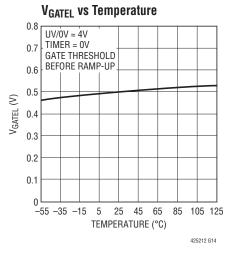


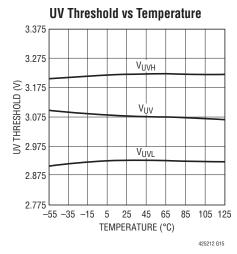


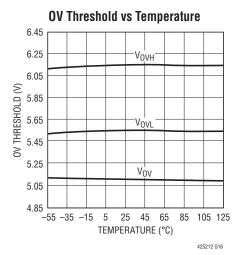


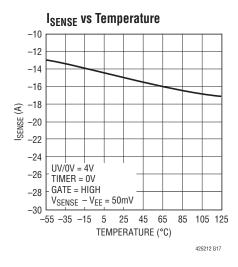


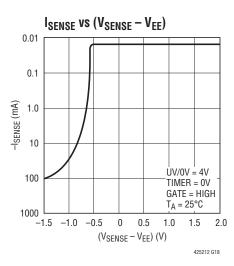


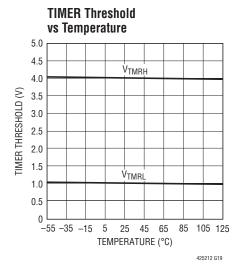


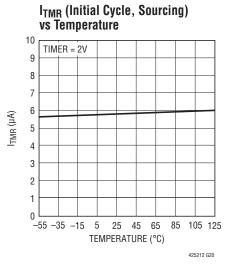


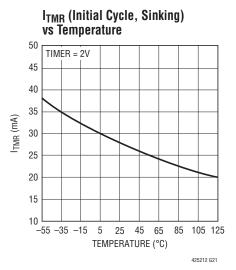




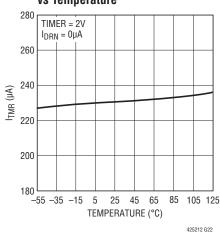




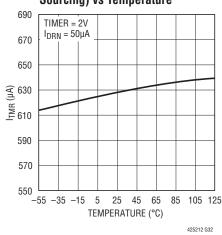




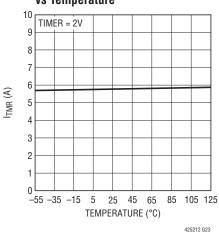
I_{TMR} (Circuit Breaker, Sourcing) vs Temperature



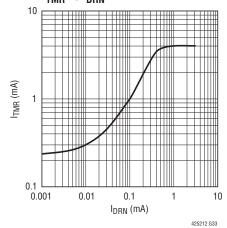
 I_{TMR} (Circuit Breaker, $I_{DRN} = 50\mu A$, Sourcing) vs Temperature



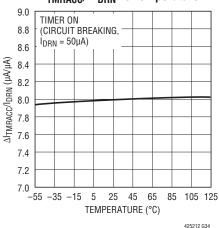
I_{TMR} (Cooling Cycle, Sinking) vs Temperature



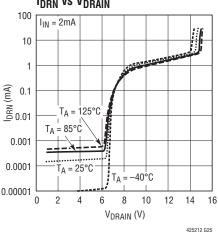
I_{TMR} vs I_{DRN}



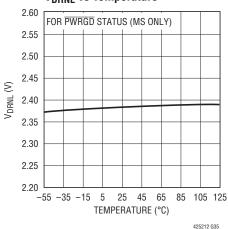
∆I_{TMRACC}/∆I_{DRN} vs Temperature



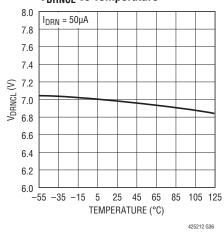
I_{DRN} vs V_{DRAIN}



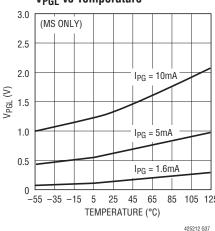
VDRNL vs Temperature



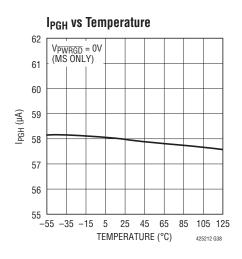
V_{DRNCL} vs Temperature

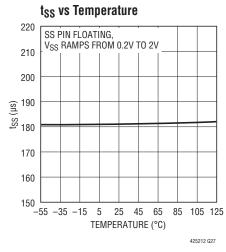


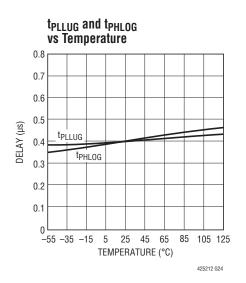
V_{PGL} vs Temperature











PIN FUNCTIONS (MS/MS8)

 V_{IN} (Pin 1/Pin 1): Positive Supply Input. Connect this pin to the positive side of the supply through a dropping resistor. A shunt regulator clamps V_{IN} at 13V. An internal undervoltage lockout (UVLO) circuit holds GATE low until the V_{IN} pin is greater than V_{LKO} , overriding UV and OV. If UV is high, OV is low and V_{IN} comes out of UVLO, TIMER starts an initial timing cycle before initiating a GATE rampup. If V_{IN} drops below approximately 8.2V, GATE pulls low immediately.

 $\overline{\text{PWRGD}}$ (Pin 2/Not Available): Power Good Status Output (MS only). At start-up, $\overline{\text{PWRGD}}$ latches low if DRAIN is below 2.385V and GATE is within 2.8V of V_{IN}. $\overline{\text{PWRGD}}$ status is reset by UV, V_{IN} (UVLO) or a circuit breaker fault timeout. This pin is internally pulled high by a 58μA current source.

SS (**Pin 3/Pin 2**): Soft-Start Pin. This pin is used to ramp inrush current during start up, thereby effecting control over di/dt. A 20x attenuated version of the SS pin voltage is presented to the current limit amplifier. This attenuated voltage limits the MOSFET's drain current through the sense resistor during the soft-start current limiting. At the beginning of a start-up cycle, the SS capacitor (C_{SS}) is ramped by a 22µA (28µA for the LTC4252A) current source. The

GATE pin is held low until SS exceeds $20 \cdot V_{OS} = 0.2V$. SS is internally shunted by a 100k resistor (R_{SS}) which limits the SS pin voltage to 2.2V (50k resistor and 1.4V for the LTC4252A). This corresponds to an analog current limit SENSE voltage of 100mV (60mV for the LTC4252A). If the SS capacitor is omitted, the SS pin ramps up in about 180 μ s. The SS pin is pulled low under any of the following conditions: in UVLO, in an undervoltage condition, in an overvoltage condition, during the initial timing cycle or when the circuit breaker fault times out.

SENSE (Pin 4/Pin 3): Circuit Breaker/Current Limit Sense Pin. Load current is monitored by a sense resistor R_S connected between SENSE and V_{EE} , and controlled in three steps. If SENSE exceeds V_{CB} (50mV), the circuit breaker comparator activates a (230 μ A + 8 • I_{DRN}) TIMER pull-up current. If SENSE exceeds V_{ACL} , the analog current limit amplifier pulls GATE down to regulate the MOSFET current at V_{ACL}/R_S . In the event of a catastrophic short-circuit, SENSE may overshoot. If SENSE reaches V_{FCL} (200mV), the fast current limit comparator pulls GATE low with a strong pull-down. To disable the circuit breaker and current limit functions, connect SENSE to V_{EE} .



PIN FUNCTIONS (MS/MS8)

V_{EE} (**Pin 5/Pin 4**): Negative Supply Voltage Input. Connect this pin to the negative side of the power supply.

GATE (Pin 6/Pin 5): N-Channel MOSFET Gate Drive Output. This pin is pulled high by a $58\mu\text{A}$ current source. GATE is pulled low by invalid conditions at V_{IN} (UVLO), UV, OV, or a circuit breaker fault timeout. GATE is actively servoed to control the fault current as measured at SENSE. A compensation capacitor at GATE stabilizes this loop. A comparator monitors GATE to ensure that it is low before allowing an initial timing cycle, GATE ramp-up after an overvoltage event or restart after a current limit fault. During GATE start-up, a second comparator detects if GATE is within 2.8V of V_{IN} before \overline{PWRGD} is set (MS package only).

DRAIN (Pin 7/Pin 6): Drain Sense Input. Connecting an external resistor, R_D , between this pin and the MOSFET's drain (V_{OUT}) allows voltage sensing below 6.15V (5V for LTC4252A) and current feedback to TIMER. A comparator detects if DRAIN is below 2.385V and together with the GATE high comparator sets the \overline{PWRGD} flag. If V_{OUT} is above V_{DRNCL} , DRAIN clamps at approximately V_{DRNCL} . The current through R_D is internally multiplied by 8 and added to TIMER's 230 μ A pullup current during a circuit breaker fault cycle. This reduces the fault time and MOSFET heating.

OV (Pin 8/Pin7): Overvoltage Input. The active high threshold at the OV pin is set at 6.15V with 0.6V hysteresis. If OV > 6.15V, GATE pulls low. When OV returns below 5.55V, GATE start-up begins without an initial timing cycle. The LTC4252A OV pin is set at 5.09V with 102mV hysteresis. If OV > 5.09V, GATE pulls low. When OV returns below 4.988V, GATE start-up begins without an initial timing cycle. If an overvoltage condition occurs in the middle of an initial timing cycle, the initial timing cycle is restarted after the overvoltage condition goes away. An overvoltage condition does not reset the \overline{PWRGD} flag. The internal UVLO at V_{IN} always overrides OV. A 1nF to 10nF capacitor at OV prevents transients and switching noise from affecting the OV thresholds and prevents glitches at the GATE pin.

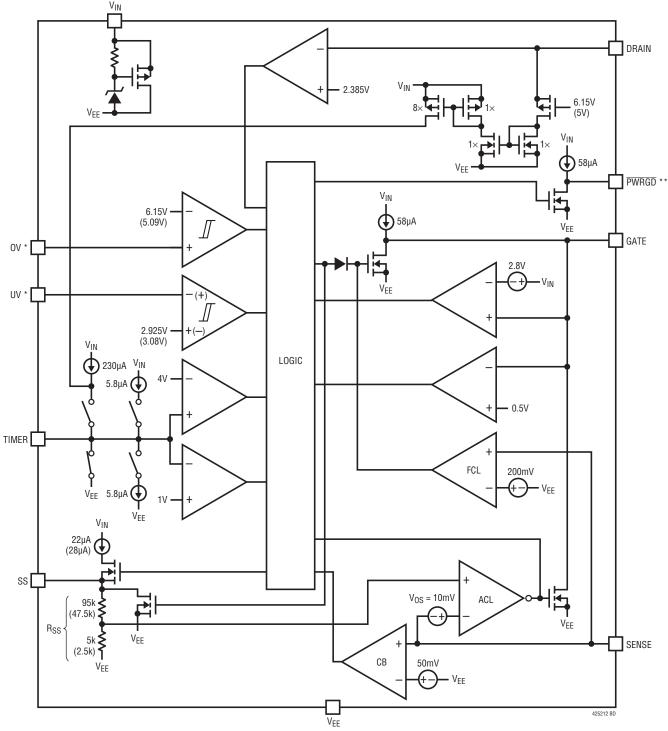
UV (Pin 9/Pin 7): Undervoltage Input. The active low threshold at the UV pin is set at 2.925V with 0.3V hysteresis. If UV < 2.925V, \overline{PWRGD} pulls high, both GATE and TIMER pull low. If UV rises above 3.225V, this initiates an initial timing cycle followed by GATE start-up. The LTC4252A UV pin is set at 3.08V with 324mV hysteresis. If UV < 2.756V, \overline{PWRGD} pulls high, both GATE and TIMER pull low. If UV rises above 3.08V, this initiates an initial timing cycle followed by GATE start-up. The internal UVLO at V_{IN} always overrides UV. A low at UV resets an internal fault latch. A 1nF to 10nF capacitor at UV prevents transients and switching noise from affecting the UV thresholds and prevents glitches at the GATE pin.

TIMER (Pin 10/Pin 8): Timer Input. TIMER is used to generate an initial timing delay at start-up and to delay shutdown in the event of an output overload (circuit breaker fault). TIMER starts an initial timing cycle when the following conditions are met: UV is high, OV is low, V_{IN} clears UVLO, TIMER pin is low, GATE is lower than V_{GATEL} , SS < 0.2V, and $V_{SENSE} - V_{EE} < V_{CB}$. A pull-up current of 5.8 μ A then charges C_T , generating a time delay. If C_T charges to V_{TMRH} (4V), the timing cycle terminates, TIMER quickly pulls low and GATE is activated.

If SENSE exceeds 50mV while GATE is high, a circuit breaker cycle begins with a 230µA pull-up current charging C_T. If DRAIN is approximately 7V (6V for LTC4252A) during this cycle, the timer pull-up has an additional current of 8 • IDRN. If SENSE drops below 50mV before TIMER reaches 4V, a 5.8µA pull-down current slowly discharges the C_T . In the event that C_T eventually integrates up to the V_{TMRH} threshold, the circuit breaker trips, GATE quickly pulls low and PWRGD pulls high. The LTC4252-1 TIMER pin latches high with a 5.8µA pull-up source. This latched fault is cleared by either pulling TIMER low with an external device or by pulling UV below V_{UVI O}. The LTC4252-2 starts a shutdown cooling cycle following an overcurrent fault. This cycle consists of 4 discharging ramps and 3 charging ramps. The charging and discharging currents are 5.8µA and TIMER ramps between its 1V and 4V thresholds. At the completion of a shutdown cooling cycle, the LTC4252-2 attempts a start-up cycle.

> LINEAR TECHNOLOGY

BLOCK DIAGRAM



*OV AND UV ARE TIED TOGETHER ON THE MS8 PACKAGE. OV AND UV ARE SEPARATE PINS ON THE MS PACKAGE ** ONLY AVAILABLE IN THE MS PACKAGE

FOR COMPONENTS, CURRENT AND VOLTAGE WITH TWO VALUES, VALUES IN PARENTHESES REFER TO THE LTC4252A. VALUES WITHOUT PARENTHESES REFER TO THE LTC4252



OPERATION

Hot Circuit Insertion

When circuit boards are inserted into a live backplane, the supply bypass capacitors can draw huge transient currents from the power bus as they charge. The flow of current damages the connector pins and glitches the power bus, causing other boards in the system to reset. The LTC4252 is designed to turn on a circuit board supply in a controlled manner, allowing insertion or removal without glitches or connector damage.

Initial Start-Up

The LTC4252 resides on a removable circuit board and controls the path between the connector and load or power conversion circuitry with an external MOSFET switch (see Figure 1). Both inrush control and short-circuit protection are provided by the MOSFET.

A detailed schematic for the LTC4252A is shown in Figure 2. –48V and –48RTN receive power through the longest connector pins and are the first to connect when the board is inserted. The GATE pin holds the MOSFET off during this time. UV and OV determine whether or not the MOSFET should be turned on based upon internal high accuracy thresholds and an external divider. UV and OV do double duty by also monitoring whether or not the connector is seated. The top of the divider detects –48RTN by way of a short connector pin that is the last to mate during the insertion sequence.

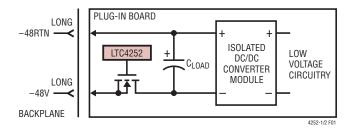


Figure 1. Basic LTC4252 Hot Swap Topology

Interlock Conditions

A start-up sequence commences once these "interlock" conditions are met.

- 1. The input voltage V_{IN} exceeds V_{LKO} (UVLO).
- 2. The voltage at $UV > V_{UVHI}$.
- 3. The voltage at $OV < V_{OVLO}$.
- 4. The (SENSE V_{EE}) voltage is < 50mV (V_{CB}).
- 5. The voltage at SS is < 0.2V (20 V_{OS}).
- 6. The voltage on the TIMER capacitor (C_T) is < 1V (V_{TMRL}).
- 7. The voltage at GATE is < 0.5 V (V_{GATEL}).

The first three conditions are continuously monitored and the latter four are checked prior to initial timing or GATE ramp-up. Upon exiting an OV condition, the TIMER pin voltage requirement is inhibited. Details are described in the Applications Information, Timing Waveforms section.

TIMER begins the start-up sequence by sourcing $5.8\mu A$ into C_T . If V_{IN} , UV or OV falls out of range, the start-up cycle stops and TIMER discharges C_T to less than 1V, then waits until the aforementioned conditions are once again met. If C_T successfully charges to 4V, TIMER pulls low and both SS and GATE pins are released. GATE sources $58\mu A$ (I_{GATE}), charging the MOSFET gate and associated capacitance. The SS voltage ramp limits V_{SENSE} to control the inrush current. \overline{PWRGD} pulls active low when GATE is within 2.8V of V_{IN} and DRAIN is lower than V_{DRNI} .

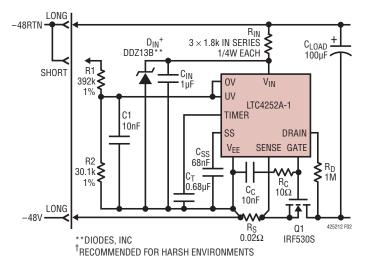


Figure 2. -48V, 2.5A Hot Swap Controller



OPERATION

Two modes of operation are possible during the time the MOSFET is first turning on, depending on the values of external components, MOSFET characteristics and nominal design current. One possibility is that the MOSFET will turn on gradually so that the inrush into the load capacitance remains a low value. The output will simply ramp to -48V and the LTC4252 will fully enhance the MOSFET. A second possibility is that the load current exceeds the soft-start current limit threshold of $[V_{SS}(t)/20 - V_{OS}]/R_{S}$. In this case the LTC4252 will ramp the output by sourcing soft-start limited current into the load capacitance. If the soft-start voltage is below 1.2V, the circuit breaker TIMER is held low. Above 1.2V. TIMER ramps up. It is important to set the timer delay so that, regardless of which start-up mode is used, the TIMER ramp is less than one circuit breaker delay time. If this condition is not met, the LTC4252-1 may shut down after one circuit breaker delay time whereas the LTC4252-2 may continue to autoretry.

Board Removal

If the board is withdrawn from the card cage, the UV and OV divider is the first to lose connection. This shuts off the MOSFET and commutates the flow of current in the connector. When the power pins subsequently separate, there is no arcing.

Current Control

Three levels of protection handle short-circuit and overload conditions. Load current is monitored by SENSE and resistor R_S . There are three distinct thresholds at SENSE: 50mV for a timed circuit breaker function; 100mV for an analog current limit loop (60mV for the LTC4252A); and 200mV for a fast, feedforward comparator which limits peak current in the event of a catastrophic short-circuit.

If, owing to an output overload, the voltage drop across R_S exceeds 50mV, TIMER sources 230 μ A into C_T . C_T eventually charges to a 4V threshold and the LTC4252 shuts off. If the overload goes away before C_T reaches 4V and SENSE measures less than 50mV, C_T slowly discharges (5.8 μ A). In this way the LTC4252's circuit breaker function responds to low duty cycle overloads and accounts for fast heating and slow cooling characteristics of the MOSFET.

Higher overloads are handled by an analog current limit loop. If the drop across R_S reaches V_{ACL} , the current limiting loop servos the MOSFET gate and maintains a constant output current of V_{ACL}/R_S . In current limit mode, V_{OUT} typically rises and this increases MOSFET heating. If $V_{OUT} > V_{DRNCL}$, connecting an external resistor, R_D , between V_{OUT} and DRAIN allows the fault timing cycle to be shortened by accelerating the charging of the TIMER capacitor. The TIMER pull-up current is increased by 8 \bullet I_{DRN} . Note that because SENSE > 50mV, TIMER charges C_T during this time and the LTC4252 will eventually shut down.

Low impedance failures on the load side of the LTC4252 coupled with 48V or more driving potential can produce current slew rates well in excess of 50A/ μ s. Under these conditions, overshoot is inevitable. A fast SENSE comparator with a threshold of 200mV detects overshoot and pulls GATE low much harder and hence much faster than the weaker current limit loop. The V_{ACL}/R_S current limit loop then takes over and servos the current as previously described. As before, TIMER runs and shuts down the LTC4252 when C_T reaches 4V.

If C_T reaches 4V, the LTC4252-1 latches off with a 5.8 μ A pull-up current source whereas the LTC4252-2 starts a shutdown cooling cycle. The LTC4252-1 circuit breaker latch is reset by either pulling UV momentarily low or dropping the input voltage V_{IN} below the internal UVLO threshold or pulling TIMER momentarily low with a switch. The LTC4252-2 retries after its shutdown cooling cycle.

Although short-circuits are the most obvious fault type, several operating conditions may invoke overcurrent protection. Noise spikes from the backplane or load, input steps caused by the connection of a second, higher voltage supply, transient currents caused by faults on adjacent circuit boards sharing the same power bus or the insertion of non-hot-swappable products could cause higher than anticipated input current and temporary detection of an overcurrent condition. The action of TIMER and C_T rejects these events allowing the LTC4252 to "ride out" temporary overloads and disturbances that could trip a simple current comparator and, in some cases, blow a fuse.



SHUNT REGULATOR

A fast responding shunt regulator clamps the V_{IN} pin to 13V (VZ). Power is derived from -48RTN by an external current limiting resistor, R_{IN} . A 1 μ F decoupling capacitor, C_{IN} filters supply transients and contributes a short delay at start- μ D.

To meet creepage requirements R_{IN} may be split into two or more series connected units. This introduces a wider total spacing than is possible with a single component while at the same time ballasting the potential across the gap under each resistor. The LTC4252 is fundamentally a low voltage device that operates with –48V as its reference ground. To further protect against arc discharge into its pins, the area in and around the LTC4252 and all associated components should be free of any other planes such as chasis ground, return, or secondary-side power and ground planes.

 V_{IN} may be biased with additional current up to 30mA to accomodate external loading such as the \overline{PWRGD} optocoupler shown in Figure 23. As an alternative to running higher current, simply buffer V_{IN} with an emitter follower as shown in Figure 3. Another method shown in Figure 19 cascodes the \overline{PWRGD} output.

 V_{IN} is rated handle 30mA within the thermal limits of the package, and is tested to survive a 100 μ s, 100mA pulse. To protect V_{IN} against damage from higher amplitude spikes, clamp V_{IN} to V_{EE} with a 13V Zener diode. Star connect V_{EE} and all V_{EE} -referred components to the sense resistor

Kelvin terminal as illustrated in Figure 3, keeping trace lengths between V_{IN} , C_{IN} , D_{IN} and V_{FF} as short as possible.

INTERNAL UNDERVOLTAGE LOCKOUT (UVLO)

A hysteretic comparator, UVLO, monitors V_{IN} for undervoltage. The thresholds are defined by V_{LKO} and its hysteresis, V_{LKH} . When V_{IN} rises above V_{LKO} the chip is enabled; below $(V_{LKO} - V_{LKH})$ it is disabled and GATE is pulled low. The UVLO function at V_{IN} should not be confused with the UV/OV pin(s). These are completely separate functions.

UV/OV COMPARATORS (LTC4252)

An UV hysteretic comparator detects undervoltage conditions at the UV pin, with the following thresholds:

UV low-to-high $(V_{IIVHI}) = 3.225V$

UV high-to-low $(V_{UVIO}) = 2.925V$

An OV hysteretic comparator detects overvoltage conditions at the OV pin, with the following thresholds:

OV low-to-high $(V_{OVHI}) = 6.150V$

OV high-to-low $(V_{OVLO}) = 5.550V$

The UV and OV trip point ratio is designed to match the standard telecom operating range of 43V to 82V when connected together as in the typical application. A divider (R1, R2) is used to scale the supply voltage. Using R1 = 402k

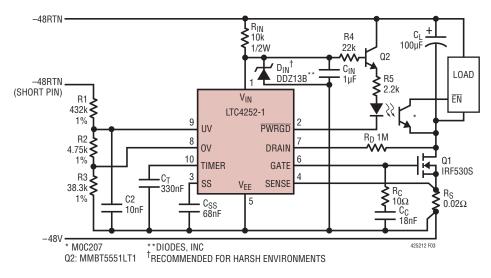


Figure 3. -48V/2.5A Application with Different Input Operating Range

and R2 = 32.4k gives a typical operating range of 43.2V to 82.5V. The undervoltage shutdown and overvoltage recovery thresholds are then 39.2V and 74.4V. 1% divider resistors are recommended to preserve threshold accuracy.

The R1-R2 divider values shown in the Typical Application set a standing current of slightly more than $100\mu A$ and define an impedance at UV/OV of $30k\Omega.$ In most applications, $30k\Omega$ impedance coupled with 300mV UV hysteresis makes the LTC4252 insensitive to noise. If more noise immunity is desired, add a 1nF to 10nF filter capacitor from UV/OV to $V_{\text{FF}}.$

Separate UV and OV pins are available in the 10-pin MS package and can be used for a different operating range such as 35.5V to 76V as shown in Figure 3. Other combinations are possible with different resistor arrangements.

UV/OV COMPARATORS (LTC4252A)

A UV hysteretic comparator detects undervoltage conditions at the UV pin, with the following thresholds:

UV low-to-high $(V_{IIV}) = 3.08V$

UV high-to-low $(V_{UV} - V_{UVHST}) = 2.756V$

An OV hysteretic comparator detects overvoltage conditions at the OV pin, with the following thresholds:

OV low-to-high $(V_{OV}) = 5.09V$

OV high-to-low $(V_{OV} - V_{OVHST}) = 4.988V$

The UV and OV trip point ratio is designed to match the standard telecom operating range of 43V to 71V when connected together as in Figure 2. A divider (R1, R2) is used to scale the supply voltage. Using R1 = 390k and R2 = 30.1k gives a typical operating range of 43V to 71V. The undervoltage shutdown and overvoltage recovery thresholds are then 38.5V and 69.6V respectively. 1% divider resistors are recommended to preserve threshold accuracy.

The R1-R2 divider values shown in Figure 2 set a standing current of slightly more than 100 μ A and define an impedance at UV/OV of 28k Ω . In most applications, 28k Ω impedance coupled with 324mV UV hysteresis makes the LTC4252A insensitive to noise. If more noise immunity is desired, add a 1nF to 10nF filter capacitor from UV/OV to V_{EE}.

The UV and OV pins can be used for a wider operating range such as 35.5V to 76V as shown in Figure 4. Other combinations are possible with different resistor arrangements.

UV/OV OPERATION

A low input to the UV comparator will reset the chip and pull the GATE and TIMER pins low. A low-to-high UV transition will initiate an initial timing sequence if the other interlock

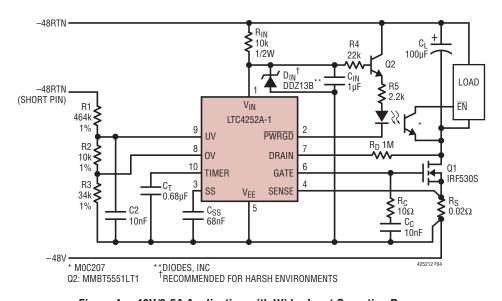


Figure 4. –48V/2.5A Application with Wider Input Operating Range



LTC4252-1/LTC4252-2 LTC4252A-1/LTC4252A-2

APPLICATIONS INFORMATION

conditions are met. A high-to-low transition in the UV comparator immediately shuts down the LTC4252, pulls the MOSFET gate low and resets the latched PWRGD high.

Overvoltage conditions detected by the OV comparator will also pull GATE low, thereby shutting down the load. However, it will not reset the circuit breaker TIMER, PWRGD flag or shutdown cooling timer. Returning the supply voltage to an acceptable range restarts the GATE pin if all the interlock conditions except TIMER are met. Only during the initial timing cycle does an OV condition reset the TIMER.

DRAIN

Connecting an external resistor, R_D , to the dual function DRAIN pin allows V_{OUT} sensing* without it being damaged by large voltage transients. Below 5V, negligible pin leakage allows a DRAIN low comparator to detect V_{OUT} less than 2.385V (V_{DRNL}). This condition, together with the GATE low comparator, sets the PWRGD flag.

If $V_{OUT} > V_{DRNCL}$, the DRAIN pin is clamped at about V_{DRNCL} and the current flowing in R_D is given by:

$$I_{DRN} \approx \frac{V_{OUT} - V_{DRNCL}}{R_D}$$
 (1)

This current is scaled up 8 times during a circuit breaker fault and is added to the nominal 230µA TIMER current. This accelerates the fault TIMER pull-up when the MOSFET's drain-source voltage exceeds V_{DRNCL} and effectively shortens the MOSFET heating duration.

TIMER

The operation of the TIMER pin is somewhat complex as it handles several key functions. A capacitor C_T is used at TIMER to provide timing for the LTC4252. Four different charging and discharging modes are available at TIMER:

- 1) A 5.8µA slow charge; initial timing and shutdown cooling delay.
- 2) A (230μA + 8 I_{DRN}) fast charge; circuit breaker delay.
- 3) A 5.8µA slow discharge; circuit breaker "cool off" and shutdown cooling.

4) Low impedance switch; resets the TIMER capacitor after an initial timing delay, in UVLO, in UV and in OV during initial timing.

For initial start-up, the $5.8\mu A$ pull-up is used. The low impedance switch is turned off and the $5.8\mu A$ current source is enabled when the interlock conditions are met. C_T charges to 4V in a time period given by:

$$t = \frac{4V \cdot C_T}{5.8\mu A} \tag{2}$$

When C_T reaches 4V (V_{TMRH}), the low impedance switch turns on and discharges C_T . A GATE start-up cycle begins and both SS and GATE are released.

CIRCUIT BREAKER TIMER OPERATION

If the SENSE pin detects more than a 50mV drop across R_S , the TIMER pin charges C_T with (230 μ A + 8 • I_{DRN}). If C_T charges to 4V, the GATE pin pulls low and the LTC4252-1 latches off while the LTC4252-2 starts a shutdown cooling cycle. The LTC4252-1 remains latched off until the UV pin is momentarily pulsed low or TIMER is momentarily discharged low by an external switch or V_{IN} dips below UVLO and is then restored. The circuit breaker timeout period is given by:

$$t = \frac{4V \cdot C_T}{230\mu A + 8 \cdot I_{DRN}}$$
 (3)

If $V_{OUT} < 5V$, an internal PMOS device isolates any DRAIN pin leakage current, making $I_{DRN} = 0\mu A$ in Equation (3). If $V_{OUT} > V_{DRNCL}$ during the circuit breaker fault period, the charging of C_T accelerates by $8 \bullet I_{DRN}$ of Equation (1).

Intermittent overloads may exceed the 50mV threshold at SENSE, but, if their duration is sufficiently short, TIMER will not reach 4V and the LTC4252 will not shut the external MOSFET off. To handle this situation, the TIMER discharges C_T slowly with a 5.8 μ A pull-down whenever the SENSE voltage is less than 50mV. Therefore, any intermittent overload with $V_{OUT} > 5V$ and an aggregate duty cycle of



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ed by the MOSPET, i.e., VDS.

^{*}V_{OUT} as viewed by the MOSFET; i.e., V_{DS}.

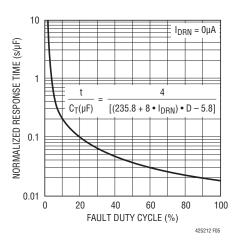


Figure 5. Circuit-Breaker Response Time

2.5% or more will eventually trip the circuit breaker and shut down the LTC4252. Figure 5 shows the circuit breaker response time in seconds normalized to $1\mu F$ for $I_{DRN}=0\mu A$. The asymmetric charging and discharging of C_T is a fair gauge of MOSFET heating.

The normalized circuit response time is estimated by

$$\frac{t}{C_{T}(\mu F)} = \frac{4}{\left[\left(235.8 + 8 \bullet I_{DRN}\right) \bullet D - 5.8\right]}$$
(4)

SHUTDOWN COOLING CYCLE

For the LTC4252-1 (latchoff version), TIMER latches high with a $5.8\mu A$ pull-up after the circuit breaker fault TIMER reaches 4V. For the LTC4252-2 (automatic retry version), a shutdown cooling cycle begins if TIMER reaches the 4V threshold. TIMER starts with a $5.8\mu A$ pull-down until it reaches the 1V threshold. Then, the $5.8\mu A$ pull-up turns back on until TIMER reaches the 4V threshold. Four $5.8\mu A$ pull-down cycles and three $5.8\mu A$ pull-up cycles occur between the 1V and 4V thresholds, creating a time interval given by:

$$t_{SHUTDOWN} = \frac{7 \cdot 3V \cdot C_T}{5.8 \mu A}$$
 (5)

At the 1V threshold of the last pull-down cycle, a GATE ramp-up is attempted.

SOFT-START

Soft-start limits the inrush current profile during GATE start-up. Unduly long soft-start intervals can exceed the MOSFET's SOA rating if powering up into an active load. If SS floats, an internal current source ramps SS from 0V to 2.2V for the LTC4252 or 0V to 1.4V for the LTC4252A in about 230 μ s. Connecting an external capacitor CSS from SS to ground modifies the ramp to approximate an RC response of:

$$V_{SS}(t) \approx V_{SS} \bullet \left(1 - e^{\left(-\frac{t}{R_{SS} \cdot C_{SS}}\right)}\right)$$
(6)

An internal resistive divider (95k/5k for the LTC4252 or 47.5k/2.5k for the LTC4252A) scales $V_{SS}(t)$ down by 20 times to give the analog current limit threshold:

$$V_{ACL}(t) = \frac{V_{SS}(t)}{20} - V_{OS}$$
 (7)

This allows the inrush current to be limited to $V_{ACL}(t)/R_S$. The offset voltage, V_{OS} (10mV), ensures C_{SS} is sufficiently discharged and the ACL amplifier is in current limit before GATE start-up. SS is pulled low under any of the following conditions: in UVLO, in an undervoltage condition, in an overvoltage condition, during the initial timing cycle or when the circuit breaker fault times out.

GATE

GATE is pulled low to V_{EE} under any of the following conditions: in UVLO, in an undervoltage condition, in an overvoltage condition, during the initial timing cycle or when the circuit breaker fault times out. When GATE turns on, a $58\mu A$ current source charges the MOSFET gate and any associated external capacitance. V_{IN} limits the gate drive to no more than 14.5V.

Gate-drain capacitance (C_{GD}) feedthrough at the first abrupt application of power can cause a gate-source voltage sufficient to turn on the MOSFET. A unique circuit pulls GATE low with practically no usable voltage at V_{IN}



and eliminates current spikes at insertion. A large external gate-source capacitor is thus unnecessary for the purpose of compensating C_{GD} . Instead, a smaller value (\geq 10nF) capacitor C_{C} is adequate. C_{C} also provides compensation for the analog current limit loop.

GATE has two comparators: the GATE low comparator looks for < 0.5V threshold prior to initial timing or a GATE start-up cycle; the GATE high comparator looks for < 2.8V relative to V_{IN} and, together with the DRAIN low comparator, sets \overline{PWRGD} status during GATE startup.

SENSE

The SENSE pin is monitored by the circuit breaker (CB) comparator, the analog current limit (ACL) amplifier and the fast current limit (FCL) comparator. Each of these three measures the potential of SENSE relative to V_{EE} . When SENSE exceeds 50mV, the CB comparator activates the 230 μ A TIMER pull-up. At 100mV (60mV for the LTC4252A), the ACL amplifier servos the MOSFET current and, at 200mV, the FCL comparator abruptly pulls GATE low in an attempt to bring the MOSFET current under control. If any of these conditions persists long enough for TIMER to charge C_T to 4V (see Equation 3), the LTC4252 shuts down and pulls GATE low.

If the SENSE pin encounters a voltage greater than V_{ACL} , the ACL amplifier will servo GATE downwards in an attempt to control the MOSFET current. Since GATE overdrives the MOSFET in normal operation, the ACL amplifier needs time to discharge GATE to the threshold of the MOSFET. For a mild overload the ACL amplifier can control the MOSFET current, but in the event of a severe overload the current may overshoot. At SENSE = 200mV the FCL comparator takes over, quickly discharging the GATE pin to near V_{EE} potential. FCL then releases and the ACL amplifier takes over. All the while TIMER is running. The effect of FCL is to add a nonlinear response to the control loop in favor of reducing MOSFET current.

Owing to inductive effects in the system, FCL typically overcorrects the current limit loop and GATE undershoots. A zero in the loop (resistor R_{C} in series with the gate capacitor) helps the ACL amplifier to recover.

SHORT-CIRCUIT OPERATION

Circuit behavior arising from a load side low impedance short is shown in Figure 6 for the LTC4252. Initially, the current overshoots the fast current limit level of $V_{SENSE} = 200 \text{mV}$ (Trace 2) as the GATE pin works to bring V_{GS} under control (Trace 3). The overshoot glitches the backplane in the negative direction and when the current is reduced to 100mV/R_S , the backplane responds by glitching in the positive direction.

TIMER commences charging C_T (Trace 4) while the analog current limit loop maintains the fault current at 100mV/R_S , which in this case is 5A (Trace 2). Note that the backplane voltage (Trace 1) sags under load. Timer pull-up is accelerated by V_{OUT} . When C_T reaches 4V, GATE turns off, PWRGD pulls high, the load current drops to zero and the backplane rings up to over 100 V. The transient associated with the GATE turn off can be controlled with a snubber to reduce ringing and a transient voltage suppressor (such as Diodes Inc. SMAT70A) to clip off large spikes. The choice of RC for the snubber is usually done experimentally. The value of the snubber capacitor is usually chosen between 10 to 100 times the MOSFET C_{OSS} . The value of the snubber resistor is typically between 3Ω to 100Ω .

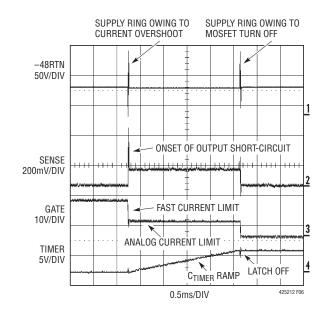


Figure 6. Output Short-Circuit Behavior of LTC4252

LINEAR TECHNOLOGY

A low impedance short on one card may influence the behavior of others sharing the same backplane. The initial glitch and backplane sag as seen in Figure 6 Trace 1, can rob charge from output capacitors on adjacent cards. When the faulty card shuts down, current flows in to refresh the capacitors. If LTC4252s are used by the other cards, they respond by limiting the inrush current to a value of 100mV/R_S . If C_T is sized correctly, the capacitors will recharge long before C_T times out.

POWER GOOD, PWRGD

 \overline{PWRGD} latches low if GATE charges up to within 2.8V of V_{IN} and DRAIN pulls below V_{DRNL} during start-up. \overline{PWRGD} is reset in UVLO, in a UV condition or if C_T charges up to 4V. An overvoltage condition has no effect on \overline{PWRGD} status. A 58µA current pulls this pin high during reset. Due to voltage transients between the power module and \overline{PWRGD} , optoisolation is recommended. This pin provides sufficent drive for an optocoupler. Figure 19 shows an alternative NPN configuration with a limiting base resistor for the \overline{PWRGD} interface. The module enable input should have protection from the negative input current.

MOSFET SELECTION

The external MOSFET switch must have adequate safe operating area (SOA) to handle short-circuit conditions until TIMER times out. These considerations take precedence over DC current ratings. A MOSFET with adequate SOA for a given application can always handle the required current, but the opposite may not be true. Consult the manufacturer's MOSFET data sheet for safe operating area and effective transient thermal impedance curves.

MOSFET selection is a 3-step process by assuming the absense of a soft-start capacitor. First, R_S is calculated and then the time required to charge the load capacitance is determined. This timing, along with the maximum short-circuit current and maximum input voltage defines an operating point that is checked against the MOSFET's SOA curve.

To begin a design, first specify the required load current and load capacitance, I_L and C_L . The circuit breaker current trip point (V_{CB}/R_S) should be set to accommodate the maximum load current. Note that maximum input current to a DC/DC converter is expected at $V_{SUPPLY(MIN)}$. R_S is given by:

$$R_{S} = \frac{V_{CB(MIN)}}{I_{L(MAX)}}$$
 (8)

where $V_{CB(MIN)}$ = 40mV (45mV for LTC4252A) represents the guaranteed minimum circuit breaker threshold.

During the initial charging process, the LTC4252 may operate the MOSFET in current limit, forcing (V_{ACL}) between 80mV to 120mV (V_{ACL} is 54mV to 66mV for LTC4252A) across R_S . The minimum inrush current is given by:

$$I_{\text{INRUSH(MIN)}} = \frac{80\text{mV}}{R_{\text{S}}} \tag{9}$$

Maximum short-circuit current limit is calculated using the maximum V_{ACL} . This gives

$$I_{SHORTCIRCUIT(MAX)} = \frac{120mV}{R_S}$$
 (10)

The TIMER capacitor C_T must be selected based on the slowest expected charging rate; otherwise TIMER might time out before the load capacitor is fully charged. A value for C_T is calculated based on the maximum time it takes the load capacitor to charge. That time is given by:

$$t_{\text{CL(CHARGE)}} = \frac{C \cdot V}{I} = \frac{C_{L} \cdot V_{\text{SUPPLY(MAX)}}}{I_{\text{INRUSH(MIN)}}}$$
(11)

The maximum current flowing in the DRAIN pin is given by:

$$I_{DRN(MAX)} = \frac{V_{SUPPLY(MAX)} - V_{DRNCL}}{R_{D}}$$
 (12)



Approximating a linear charging rate as I_{DRN} drops from $I_{DRN(MAX)}$ to zero, the I_{DRN} component in Equation (3) can be approximated with 0.5 • $I_{DRN(MAX)}$. Rearranging equation, TIMER capacitor C_T is given by:

$$C_{T} = \frac{t_{CL(CHARGE)} \cdot (230\mu A + 4 \cdot I_{DRN(MAX)})}{4V}$$
 (13)

Returning to Equation (3), the TIMER period is calculated and used in conjunction with $V_{SUPPLY(MAX)}$ and $I_{SHORTCIRCUIT(MAX)}$ to check the SOA curves of a prospective MOSFET.

As a numerical design example, consider a 30W load, which requires 1A input current at 36V. If $V_{SUPPLY(MAX)} = 72V$ and $C_L = 100\mu F$, $R_D = 1M\Omega$, Equation (8) gives $R_S = 40m\Omega$; Equation (13) gives $C_T = 441n F$. To account for errors in R_S , C_T , TIMER current (230 μ A), TIMER threshold (4V), R_D , DRAIN current multiplier and DRAIN voltage clamp (V_{DRNCL}), the calculated value should be multiplied by 1.5, giving the nearest standard value of $C_T = 680n F$.

If a short-circuit occurs, a current of up to 120 mV/40 m Ω =3A will flow in the MOSFET for 5.6 ms as dictated by C_T=680 nF in Equation (3). The MOSFET must be selected based on this criterion. The IRF530S can handle 100V and 3A for 10 ms and is safe to use in this application.

Computing the maximum soft-start capacitor value during soft-start to a load short is complicated by the nonlinear MOSFET's SOA characteristics and the $R_{SS}C_{SS}$ response. An overly conservative but simple approach begins with the maximum circuit breaker current, given by:

$$I_{CB(MAX)} = \frac{V_{CB(MAX)}}{R_S}$$
 (14)

where $V_{CB(MAX)} = 60 \text{mV}$ (55mV for the LTC4252A).

From the SOA curves of a prospective MOSFET, determine the time allowed, t_{SOA(MAX)}. C_{SS} is given by:

$$C_{SS} = \frac{t_{SOA(MAX)}}{0.916 \cdot R_{SS}}$$
(15)

In the above example, $60\text{mV}/40\text{m}\Omega$ gives 1.5A. $t_{SOA(MAX)}$ for the IRF530S is 40ms. From Equation (15), C_{SS} = 437nF. Actual board evaluation showed that C_{SS} = 100nF

was appropriate. The ratio ($R_{SS} \bullet C_{SS}$) to $t_{CL(CHARGE)}$ is a good gauge as a large ratio may result in the time-out period expiring. This gauge is determined empirically with board level evaluation.

SUMMARY OF DESIGN FLOW

To summarize the design flow, consider the application shown in Figure 2 with the LTC4252A. It was designed for 80W.

Calculate the maximum load current: 80W/43V = 1.86A; allowing for 83% converter efficiency, $I_{IN(MAX)} = 2.2A$.

Calculate R_S : from Equation (8) $R_S = 20m\Omega$.

Calculate I_{SHORTCIRCUIT(MAX)}: from Equation (10)

$$I_{SHORTCIRCUIT(MAX)} = \frac{66mV}{20m\Omega} = 3.3A$$

Select a MOSFET that can handle 3.3A at 71V: IRF530S.

Calculate C_T : from Equation (13) $C_T = 322nF$. Select $C_T = 680nF$, which gives the circuit breaker time-out period t = 5.6ms.

Consult MOSFET SOA curves: the IRF530S can handle 3.3A at 100V for 8.2ms, so it is safe to use in this application.

Calculate C_{SS} : using Equations (14) and (15) select $C_{SS} = 68nF$.

FREQUENCY COMPENSATION

The LTC4252A typical frequency compensation network for the analog current limit loop is a series R_C (10 Ω) and C_C connected to V_{EE} . Figure 7 depicts the relationship between the compensation capacitor C_C and the MOSFET's C_{ISS} . The line in Figure 7 is used to select a starting value for C_C based upon the MOSFET's C_{ISS} specification. Optimized values for C_C are shown for several popular MOSFETs. Differences in the optimized value of C_C versus the starting value are small. Nevertheless, compensation values should be verified by board level short-circuit testing.



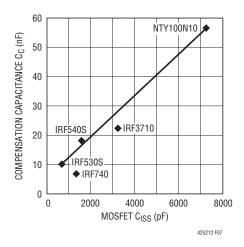


Figure 7. Recommended Compensation Capacitor C_C vs MOSFET C_{ISS}

As seen in Figure 6 previously, at the onset of a short-circuit event, the input supply voltage can ring dramatically owing to series inductance. If this voltage avalanches the MOSFET, current continues to flow through the MOSFET to the output. The analog current limit loop cannot control this current flow and therefore the loop undershoots. This effect cannot be eliminated by frequency compensation. A zener diode is required to clamp the input supply voltage and prevent MOSFET avalanche.

SENSE RESISTOR CONSIDERATIONS

For proper circuit breaker operation, Kelvin-sense PCB connections between the sense resistor and the LTC4252's V_{EE} and SENSE pins are strongly recommended. The drawing in Figure 8 illustrates the correct way of making connections between the LTC4252 and the sense resistor. PCB layout should be balanced and symmetrical to minimize wiring errors. In addition, the PCB layout for the sense resistor should include good thermal management techniques for optimal sense resistor power dissipation.

TIMING WAVEFORMS

System Power-Up

Figure 9 details the timing waveforms for a typical powerup sequence in the case where a board is already installed in the backplane and system power is applied abruptly. At

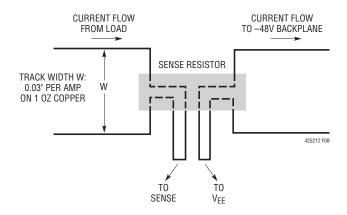


Figure 8. Making PCB Connections to the Sense Resistor

time point 1, the supply ramps up, together with UV/OV, V_{OUT} and DRAIN. V_{IN} and PWRGD follow at a slower rate as set by the V_{IN} bypass capacitor. At time point 2, V_{IN} exceeds V_{IKO} and the internal logic checks for $UV > V_{UVHI}$, OV < V_{OVLO}, GATE < V_{GATEL}, SENSE < V_{CB}, SS < 20 • V_{OS} and TIMER < V_{TMRI} . If all conditions are met, an initial timing cycle starts and the TIMER capacitor is charged by a 5.8µA current source pull-up. At time point 3, TIMER reaches the V_{TMRH} threshold and the initial timing cycle terminates. The TIMER capacitor is quickly discharged. At time point 4, the V_{TMRI} threshold is reached and the conditions of GATE < V_{GATEL}, SENSE < V_{CB} and SS < 20 \bullet V_{OS} must be satisfied before a GATE ramp-up cycle begins. SS ramps up as dictated by $R_{SS} \cdot C_{SS}$ (as in Equation 6); GATE is held low by the analog current limit (ACL) amplifier until SS crosses 20 • V_{OS}. Upon releasing GATE, 58μA sources into the external MOSFET gate and compensation network. When the GATE voltage reaches the MOSFET's threshold, current begins flowing into the load capacitor at time point 5. At time point 6, load current reaches the SS control level and the analog current limit loop activates. Between time points 6 and 8, the GATE voltage is servoed, the SENSE voltage is regulated at $V_{ACL}(t)$ (Equation 7) and soft-start limits the slew rate of the load current. If the SENSE voltage (V_{SENSE} – V_{EE}) reaches the V_{CB} threshold at time point 7, the circuit breaker TIMER activates. The TIMER capacitor, C_T, is charged by a (230µA + 8 • I_{DRN}) current pull-up. As the load capacitor nears full charge, load current begins to decline.



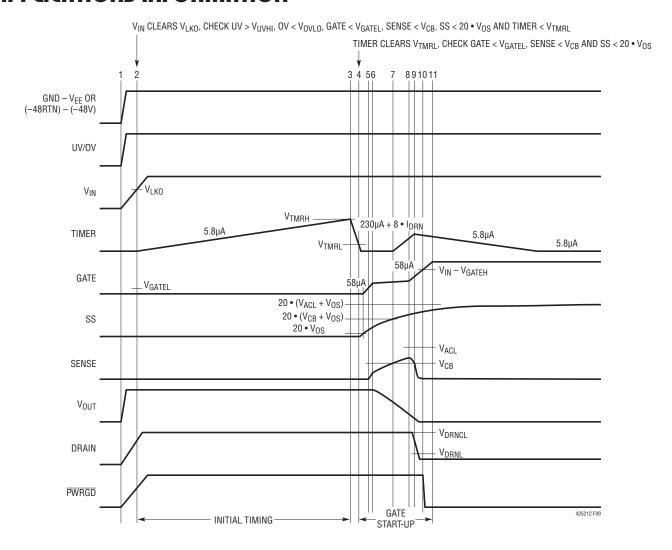


Figure 9. System Power-Up Timing (All Waveforms Are Referenced to V_{FF})

At time point 8, the load current falls and the SENSE voltage drops below $V_{ACL}(t)$. The analog current limit loop shuts off and the GATE pin ramps further. At time point 9, the SENSE voltage drops below V_{CB} , the fault TIMER cycle ends, followed by a 5.8 μ A discharge cycle (cool off). The duration between time points 7 and 9 must be shorter than one circuit breaker delay to avoid a fault time out during GATE ramp-up. When GATE ramps past the V_{GATEH} threshold at time point 10, \overline{PWRGD} pulls low. At time point 11, GATE reaches its maximum voltage as determined by V_{IN} .

Live Insertion with Short Pin Control of UV/OV

In the example shown in Figure 10, power is delivered through long connector pins whereas the UV/OV divider

makes contact through a short pin. This ensures the power connections are firmly established before the LTC4252 is activated. At time point 1, the power pins make contact and V_{IN} ramps through $V_{LKO}.$ At time point 2, the UV/OV divider makes contact and its voltage exceeds $V_{UVHI}.$ In addition, the internal logic checks for OV < $V_{OVHI},$ GATE < $V_{GATEL},$ SENSE < $V_{CB},$ SS < 20 \bullet V_{OS} and TIMER < $V_{TMRL}.$ If all conditions are met, an initial timing cycle starts and the TIMER capacitor is charged by a 5.8 μ A current source pull-up. At time point 3, TIMER reaches the V_{TMRH} threshold and the initial timing cycle terminates. The TIMER capacitor is quickly discharged. At time point 4, the V_{TMRL} threshold is reached and the conditions of GATE < $V_{GATEL},$ SENSE < V_{CB} and SS < 20 \bullet V_{OS} must be



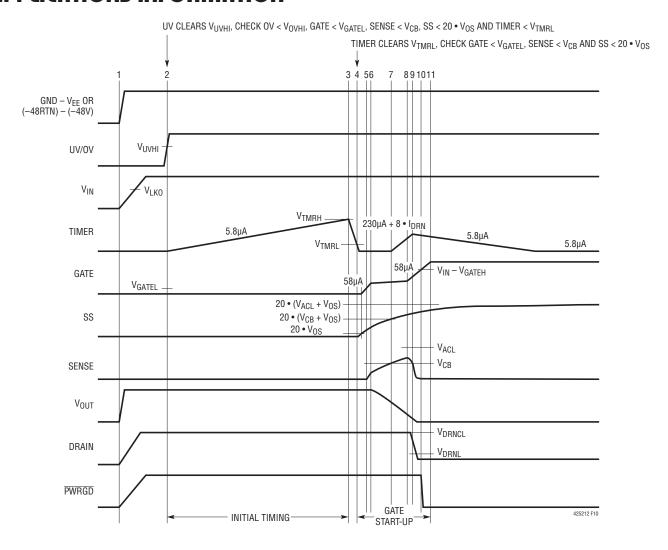


Figure 10. Power-Up Timing with a Short Pin (All Waveforms Are Referenced to V_{EE})

satisfied before a GATE start-up cycle begins. SS ramps up as dictated by $R_{SS} \bullet C_{SS};$ GATE is held low by the analog current limit amplifier until SS crosses $20 \bullet V_{OS}.$ Upon releasing GATE, $58\mu A$ sources into the external MOSFET gate and compensation network. When the GATE voltage reaches the MOSFET's threshold, current begins flowing into the load capacitor at time point 5. At time point 6, load current reaches the SS control level and the analog current limit loop activates. Between time points 6 and 8, the GATE voltage is servoed, the SENSE voltage is regulated at $V_{ACL}(t)$ and soft-start limits the slew rate of the load current. If the SENSE voltage ($V_{SENSE} - V_{EE}$) reaches the

 V_{CB} threshold at time point 7, the circuit breaker TIMER activates. The TIMER capacitor, C_T , is charged by a (230μA + 8 • I_{DRN}) current pull-up. As the load capacitor nears full charge, load current begins to decline. At point 8, the load current falls and the SENSE voltage drops below $V_{ACL}(t)$. The analog current limit loop shuts off and the GATE pin ramps further. At time point 9, the SENSE voltage drops below V_{CB} and the fault TIMER cycle ends, followed by a 5.8μA discharge cycle (cool off). When GATE ramps past V_{GATEH} threshold at time point 10, \overline{PWRGD} pulls low. At time point 11, GATE reaches its maximum voltage as determined by V_{IN} .



Undervoltage Timing

In Figure 11 when UV pin drops below V_{UVLO} (time point 1), the LTC4252 shuts down with TIMER, SS and GATE all pulling low. If current has been flowing, the SENSE pin voltage decreases to zero as GATE collapses. When UV recovers and clears V_{UVHI} (time point 2), an initial timer cycle begins followed by a GATE start-up cycle.

V_{IN} Undervoltage Lockout Timing

The V_{IN} undervoltage lockout comparator, UVLO, has a similar timing behavior as the UV pin timing except it looks for $V_{IN} < (V_{LKO} - V_{LKH})$ to shut down and $V_{IN} > V_{LKO}$ to start. In an undervoltage lockout condition, both UV and OV comparators are held off. When V_{IN} exits undervoltage lockout, the UV and OV comparators are enabled.

Undervoltage Timing with Overvoltage Glitch

In Figure 12, both UV and OV pins are connected together. When UV clears V_{UVHI} (time point 1), an initial timing

cycle starts. If the system bus voltage overshoots V_{OVHI} as shown at time point 2, TIMER discharges. At time point 3, the supply voltage recovers and drops below the V_{OVLO} threshold. The initial timing cycle restarts, followed by a GATE start-up cycle.

Overvoltage Timing

During normal operation, if the OV pin exceeds V_{OVHI} as shown at time point 1 of Figure 13, the TIMER and \overline{PWRGD} status are unaffected. Nevertheless, SS and GATE pull down and the load is disconnected. At time point 2, OV recovers and drops below the V_{OVLO} threshold. A GATE start-up cycle begins. If the overvoltage glitch is long enough to deplete the load capacitor, a full start-up cycle as shown between time points 4 through 7 may occur.

Circuit Breaker Timing

In Figure 14a, the TIMER capacitor charges at 230 μ A if the SENSE pin exceeds V_{CB} but V_{DRN} is less than 5V. If the SENSE pin drops below V_{CB} before TIMER reaches

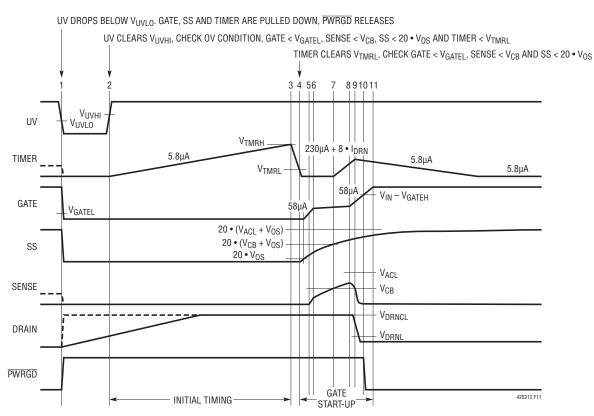


Figure 11. Undervoltage Timing (All Waveforms Are Referenced to V_{EE})

LINEAR TECHNOLOGY

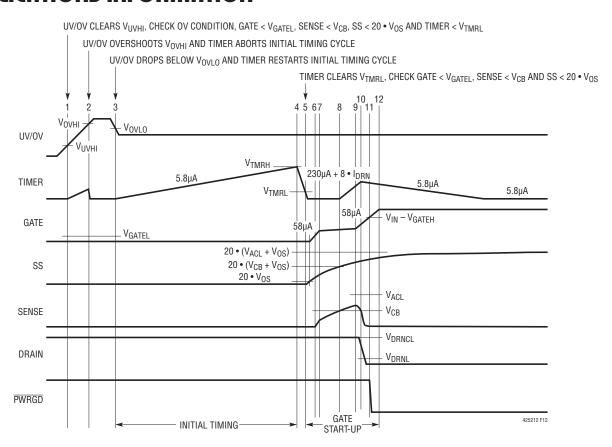


Figure 12. Undervoltage Timing with an Overvoltage Glitch (All Waveforms Are Referenced to V_{EE})

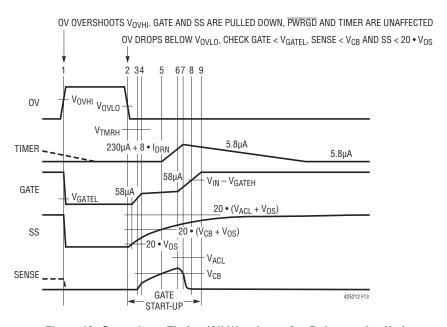


Figure 13. Overvoltage Timing (All Waveforms Are Referenced to V_{EE})

